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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Last Time Buy
Core Processor	8051
Core Size	8-Bit
Speed	25MHz
Connectivity	SMBus (2-Wire/I²C), UART/USART
Peripherals	POR, PWM, Temp Sensor, WDT
Number of I/O	8
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 8x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	14-SOIC (0.154", 3.90mm Width)
Supplier Device Package	14-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f300-gsr

Perhaps the most unique Port I/O enhancement is the Digital Crossbar. This is essentially a digital switching network that allows mapping of internal digital system resources to Port I/O pins (See Figure 1.7). On-chip counter/timers, serial buses, HW interrupts, comparator output, and other digital signals in the controller can be configured to appear on the Port I/O pins specified in the Crossbar Control registers. This allows the user to select the exact mix of general purpose Port I/O and digital resources needed for the particular application.

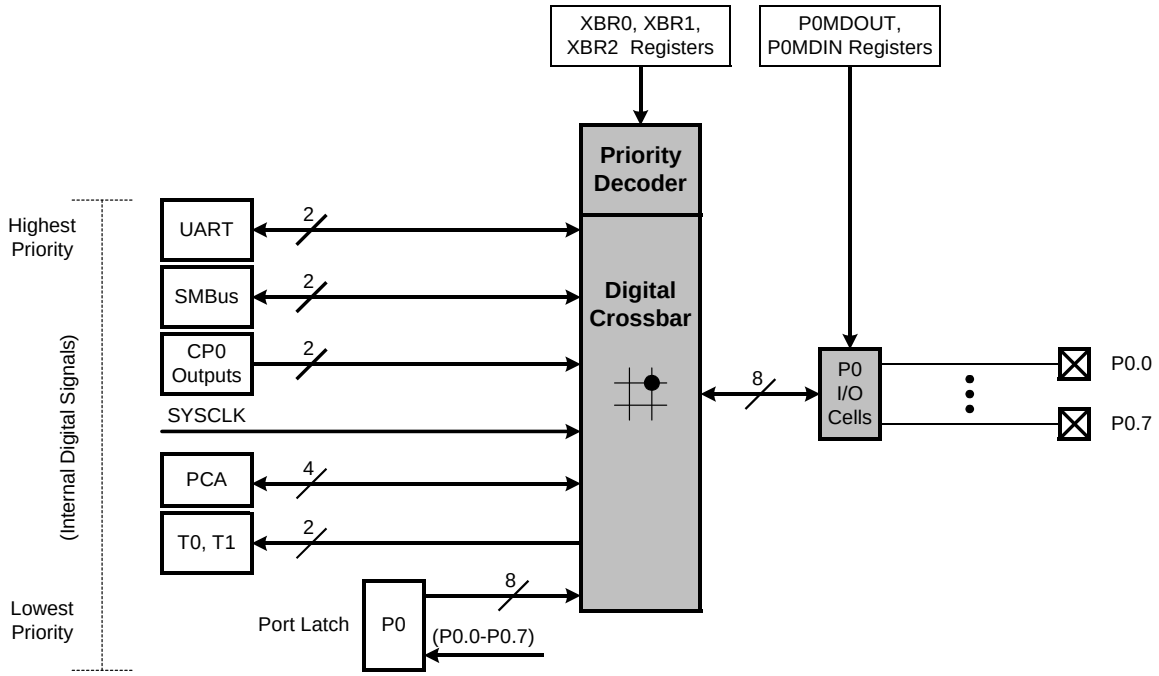

Figure 1.7. Digital Crossbar Diagram

1.5. Serial Ports

The C8051F300/1/2/3/4/5 Family includes an SMBus/I^2C interface and a full-duplex UART with enhanced baud rate configuration. Each of the serial buses is fully implemented in hardware and makes extensive use of the CIP-51's interrupts, thus requiring very little CPU intervention.

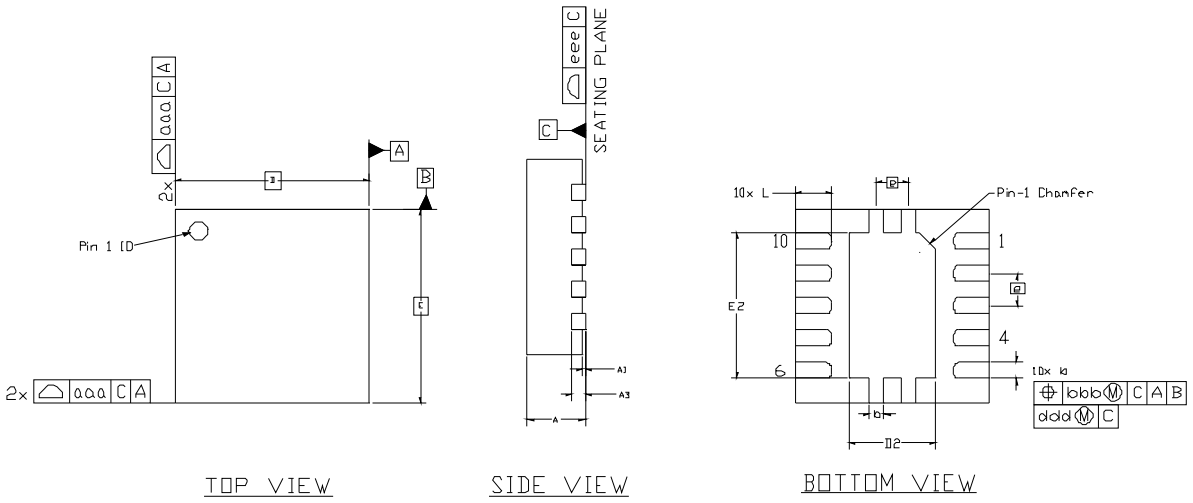

Figure 4.2. QFN-11 Package Drawing

Table 4.2. QFN-11 Package Dimensions

Dimension	Min	Nom	Max	Dimension	Min	Nom	Max
A	0.80	0.90	1.00	E	3.00 BSC.		
A1	0.03	0.07	0.11	E2	2.20	2.25	2.30
A3	0.25 REF			L	.45	.55	.65
b	0.18	0.25	0.30	aaa	--	--	0.15
D	3.00 BSC.			bbb	--	--	0.15
D2	1.30	1.35	1.40	ddd	--	--	0.05
e	0.50 BSC.			eee	--	--	0.08

Notes:

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
3. This drawing conforms to JEDEC outline MO-243, variation VEED except for custom features D2, E2, and L which are toleranced per supplier designation.
4. Recommended card reflow profile is per the JEDEC/IPC J-STD-020C specification for Small Body Components.

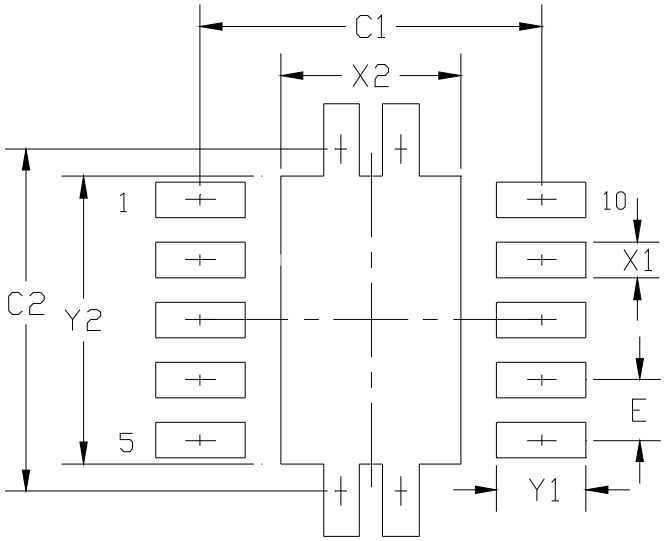

Figure 4.4. Typical QFN-11 Landing Diagram

Table 4.3. QFN-11 Landing Diagram Dimensions

Dimension	MIN	MAX
C1	2.75	2.85
C2	2.75	2.85
E	0.50 BSC	
X1	0.20	0.30
X2	1.40	1.50
Y1	0.65	0.75
Y2	2.30	2.40

Notes: General
1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. This land pattern design is based on the IPC-7351 guidelines.

Notes: Solder Mask Design
1. All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be 60 µm minimum, all the way around the pad.

Notes: Stencil Design
1. A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.
2. The stencil thickness should be 0.125 mm (5 mils).
3. The ratio of stencil aperture to land pad size should be 1:1 for all perimeter pads.
4. A 3 x 1 array of 1.30 x 0.60 mm openings on 0.80 mm pitch should be used for the center ground pad.

Notes: Card Assembly
1. A No-Clean, Type-3 solder paste is recommended.
2. The recommended card reflow profile is per the JEDEC/IPC J-STD-020C specification for Small Body Components.

5.4.2. Window Detector In Differential Mode

Figure 5.7 shows two example window comparisons for differential mode, with ADC0LT = 0x10 (+16d) and ADC0GT = 0xFF (–1d). Notice that in Differential mode, the codes vary from –VREF to VREF x (127/128) and are represented as 8-bit 2's complement signed integers. In the left example, an AD0WINT interrupt will be generated if the ADC0 conversion word (ADC0L) is within the range defined by ADC0GT and ADC0LT (if 0xFF (–1d) < ADC0 < 0x10 (16d)). In the right example, an AD0WINT interrupt will be generated if ADC0 is outside of the range defined by ADC0GT and ADC0LT (if ADC0 < 0xFF (–1d) or ADC0 > 0x10 (+16d)).

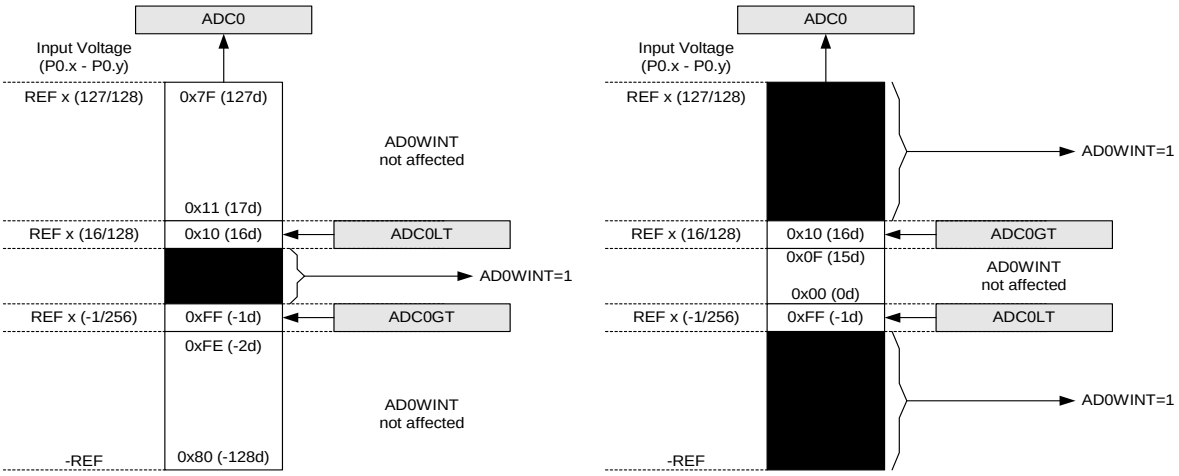

Figure 5.7. ADC Window Compare Examples, Differential Mode

SFR Definition 5.5. ADC0GT: ADC0 Greater-Than Data Byte (C8051F300/2)

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								11111111
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xC4

Bits7–0: ADC0 Greater-Than Data Word.

SFR Definition 5.6. ADC0LT: ADC0 Less-Than Data Byte (C8051F300/2)

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xC6

Bits7–0: ADC0 Less-Than Data Word.

SFR Definition 8.5. ACC: Accumulator

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
ACC.7	ACC.6	ACC.5	ACC.4	ACC.3	ACC.2	ACC.1	ACC.0	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
							(bit addressable)	0xE0

Bits7–0: ACC: Accumulator.
This register is the accumulator for arithmetic operations.

SFR Definition 8.6. B: B Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
B.7	B.6	B.5	B.4	B.3	B.2	B.1	B.0	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
							(bit addressable)	0xF0

Bits7–0: B: B Register.
This register serves as a second accumulator for certain arithmetic operations.

8.3.5. Interrupt Register Descriptions

The SFRs used to enable the interrupt sources and set their priority level are described below. Refer to the datasheet section associated with a particular on-chip peripheral for information regarding valid interrupt conditions for the peripheral and the behavior of its interrupt-pending flag(s).

SFR Definition 8.7. IE: Interrupt Enable

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
EA	IEGF0	ET2	ES0	ET1	EX1	ET0	EX0	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
							(bit addressable)	0xA8

Bit7: EA: Enable All Interrupts.
This bit globally enables/disables all interrupts. It overrides the individual interrupt mask settings.
0: Disable all interrupt sources.
1: Enable each interrupt according to its individual mask setting.

Bit6: IEGF0: General Purpose Flag 0.
This is a general purpose flag for use under software control.

Bit5: ET2: Enable Timer 2 Interrupt.
This bit sets the masking of the Timer 2 interrupt.
0: Disable Timer 2 interrupt.
1: Enable interrupt requests generated by the TF2L or TF2H flags.

Bit4: ES0: Enable UART0 Interrupt.
This bit sets the masking of the UART0 interrupt.
0: Disable UART0 interrupt.
1: Enable UART0 interrupt.

Bit3: ET1: Enable Timer 1 Interrupt.
This bit sets the masking of the Timer 1 interrupt.
0: Disable all Timer 1 interrupt.
1: Enable interrupt requests generated by the TF1 flag.

Bit2: EX1: Enable External Interrupt 1.
This bit sets the masking of external interrupt 1.
0: Disable external interrupt 1.
1: Enable interrupt requests generated by the /INT1 input.

Bit1: ET0: Enable Timer 0 Interrupt.
This bit sets the masking of the Timer 0 interrupt.
0: Disable all Timer 0 interrupt.
1: Enable interrupt requests generated by the TF0 flag.

Bit0: EX0: Enable External Interrupt 0.
This bit sets the masking of external interrupt 0.
0: Disable external interrupt 0.
1: Enable interrupt requests generated by the /INT0 input.

8.4.2. Stop Mode

Setting the Stop Mode Select bit (PCON.1) causes the CIP-51 to enter Stop mode as soon as the instruction that sets the bit completes execution. In Stop mode the internal oscillator, CPU, and all digital peripherals are stopped; the state of the external oscillator circuit is not affected. Each analog peripheral (including the external oscillator circuit) may be shut down individually prior to entering Stop Mode. Stop mode can only be terminated by an internal or external reset. On reset, the CIP-51 performs the normal reset sequence and begins program execution at address 0x0000.

If enabled, the Missing Clock Detector will cause an internal reset and thereby terminate the Stop mode. The Missing Clock Detector should be disabled if the CPU is to be put to in STOP mode for longer than the MCD timeout of 100 µsec.

SFR Definition 8.12. PCON: Power Control

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
GF5	GF4	GF3	GF2	GF1	GF0	STOP	IDLE	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0x87

Bits7–2: GF5–GF0: General Purpose Flags 5-0.
These are general purpose flags for use under software control.

Bit1: STOP: Stop Mode Select.
Setting this bit will place the CIP-51 in Stop mode. This bit will always be read as 0.
1: CPU goes into Stop mode (turns off internal oscillator).

Bit0: IDLE: Idle Mode Select.
Setting this bit will place the CIP-51 in Idle mode. This bit will always be read as 0.
1: CPU goes into Idle mode (shuts off clock to CPU, but clock to Timers, Interrupts, Serial Ports, and Analog Peripherals are still active).

bit in register RSTSRC. See Figure 9.2 for V_{DD} monitor timing; note that the reset delay is not incurred after a V_{DD} monitor reset. See Table 9.2 for electrical characteristics of the V_{DD} monitor.

Important Note: Enabling the V_{DD} monitor will immediately generate a system reset. The device will then return from the reset state with the V_{DD} monitor enabled. **Writing a logic '1' to the PORSF flag when the V_{DD} monitor is enabled does not cause a system reset.**

9.3. External Reset

The external $\overline{\text{RST}}$ pin provides a means for external circuitry to force the device into a reset state. Asserting an active-low signal on the $\overline{\text{RST}}$ pin generates a reset; an external pullup and/or decoupling of the $\overline{\text{RST}}$ pin may be necessary to avoid erroneous noise-induced resets. See Table 9.2 for complete $\overline{\text{RST}}$ pin specifications. The PINRSF flag (RSTSRC.0) is set on exit from an external reset.

9.4. Missing Clock Detector Reset

The Missing Clock Detector (MCD) is a one-shot circuit that is triggered by the system clock. If the system clock remains high or low for more than 100 µs, the one-shot will time out and generate a reset. After a MCD reset, the MCDRSF flag (RSTSRC.2) will read '1', signifying the MCD as the reset source; otherwise, this bit reads '0'. Writing a '1' to the MCDRSF bit enables the Missing Clock Detector; writing a '0' disables it. The state of the $\overline{\text{RST}}$ pin is unaffected by this reset.

9.5. Comparator0 Reset

Comparator0 can be configured as a reset source by writing a '1' to the C0RSEF flag (RSTSRC.5). Comparator0 should be enabled and allowed to settle prior to writing to C0RSEF to prevent any turn-on chatter on the output from generating an unwanted reset. The Comparator0 reset is active-low: if the non-inverting input voltage (on CP0+) is less than the inverting input voltage (on CP0–), the device is put into the reset state. After a Comparator0 reset, the C0RSEF flag (RSTSRC.5) will read '1' signifying Comparator0 as the reset source; otherwise, this bit reads '0'. The state of the $\overline{\text{RST}}$ pin is unaffected by this reset.

9.6. PCA Watchdog Timer Reset

The programmable Watchdog Timer (WDT) function of the Programmable Counter Array (PCA) can be used to prevent software from running out of control during a system malfunction. The PCA WDT function can be enabled or disabled by software as described in **Section "16.3. Watchdog Timer Mode" on page 164**; the WDT is enabled and clocked by SYSCLK / 12 following any reset. If a system malfunction prevents user software from updating the WDT, a reset is generated and the WDTRSF bit (RSTSRC.5) is set to '1'. The state of the $\overline{\text{RST}}$ pin is unaffected by this reset.

NOTES:

SFR Definition 11.3. OSCXCN: External Oscillator Control

R	R/W	R/W	R/W	R	R/W	R/W	R/W	Reset Value
XTLVLD	XOSCMD2	XOSCMD1	XOSCMD0	—	XFCN2	XFCN1	XFCN0	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
								0xB1

Bit7: XTLVLD: Crystal Oscillator Valid Flag.
(Read only when XOSCMD = 11x.)
0: Crystal Oscillator is unused or not yet stable.
1: Crystal Oscillator is running and stable.

Bits6–4: XOSCMD2-0: External Oscillator Mode Bits.
00x: External Oscillator circuit off.
010: External CMOS Clock Mode.
011: External CMOS Clock Mode with divide by 2 stage.
100: RC Oscillator Mode with divide by 2 stage.
101: Capacitor Oscillator Mode with divide by 2 stage.
110: Crystal Oscillator Mode.
111: Crystal Oscillator Mode with divide by 2 stage.

Bit3: RESERVED. Read = 0, Write = don't care.

Bits2–0: XFCN2-0: External Oscillator Frequency Control Bits.
000-111: See table below:

XFCN	Crystal (XOSCMD = 11x)	RC (XOSCMD = 10x)	C (XOSCMD = 10x)
000	f ≤ 32 kHz	f ≤ 25 kHz	K Factor = 0.87
001	32 kHz < f ≤ 84 kHz	25 kHz < f ≤ 50 kHz	K Factor = 2.6
010	84 kHz < f ≤ 225 kHz	50 kHz < f ≤ 100 kHz	K Factor = 7.7
011	225 kHz < f ≤ 590 kHz	100 kHz < f ≤ 200 kHz	K Factor = 22
100	590 kHz < f ≤ 1.5 MHz	200 kHz < f ≤ 400 kHz	K Factor = 65
101	1.5 MHz < f ≤ 4 MHz	400 kHz < f ≤ 800 kHz	K Factor = 180
110	4 MHz < f ≤ 10 MHz	800 kHz < f ≤ 1.6 MHz	K Factor = 664
111	10 MHz < f ≤ 30 MHz	1.6 MHz < f ≤ 3.2 MHz	K Factor = 1590

CRYSTAL MODE (Circuit from Figure 11.1, Option 1; XOSCMD = 11x)
Choose XFCN value to match crystal frequency.

RC MODE (Circuit from Figure 11.1, Option 2; XOSCMD = 10x)
Choose XFCN value to match frequency range:
$f = 1.23(10^3) / (R \times C)$, where
f = frequency of oscillation in MHz
C = capacitor value in pF
R = Pull-up resistor value in kΩ

C MODE (Circuit from Figure 11.1, Option 3; XOSCMD = 10x)
Choose K Factor (KF) for the oscillation frequency desired:
$f = KF / (C \times V_{DD})$, where
f = frequency of oscillation in MHz
C = capacitor value the XTAL2 pin in pF
V_{DD} = Power Supply on MCU in volts

SFR Definition 12.3. XBR2: Port I/O Crossbar Register 2

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
WEAKPUD	XBARE	—	—	—	T1E	T0E	ECIE	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
								0xE3

Bit7: WEAKPUD: Port I/O Weak Pull-up Disable.
0: Weak Pull-ups enabled (except for Ports whose I/O are configured as push-pull).
1: Weak Pull-ups disabled.
Bit6: XBARE: Crossbar Enable.
0: Crossbar disabled.
1: Crossbar enabled.
Bits5–3: UNUSED: Read = 000b. Write = don’t care.
Bit2: T1E: T1 Enable.
0: T1 unavailable at Port pin.
1: T1 routed to Port pin.
Bit1: T0E: T0 Enable.
0: T0 unavailable at Port pin.
1: T0 routed to Port pin.
Bit0: ECIE: PCA0 Counter Input Enable.
0: ECI unavailable at Port pin.
1: ECI routed to Port pin.

12.3. General Purpose Port I/O

Port pins that remain unassigned by the Crossbar and are not used by analog peripherals can be used for general purpose I/O. Port0 is accessed through a corresponding special function register (SFR) that is both byte addressable and bit addressable. When writing to a Port, the value written to the SFR is latched to maintain the output data value at each pin. When reading, the logic levels of the Port's input pins are returned regardless of the XBRn settings (i.e., even when the pin is assigned to another signal by the Crossbar, the Port register can always read its corresponding Port I/O pin). The exception to this is the execution of the read-modify-write instructions. The read-modify-write instructions when operating on a Port SFR are the following: ANL, ORL, XRL, JBC, CPL, INC, DEC, DJNZ and MOV, CLR or SET, when the destination is an individual bit in a Port SFR. For these instructions, the value of the register (not the pin) is read, modified, and written back to the SFR.

NOTES:

Table 14.1. Timer Settings for Standard Baud Rates Using The Internal 24.5 MHz Oscillator

	Frequency: 24.5 MHz						
	Target Baud Rate (bps)	Baud Rate % Error	Oscillator Divide Factor	Timer Clock Source	SCA1–SCA0 (pre-scale select)[1]	T1M[1]	Timer 1 Reload Value (hex)
SYSCLK from Internal Osc.	230400	–0.32%	106	SYSCLK	XX[2]	1	0xCB
	115200	–0.32%	212	SYSCLK	XX[2]	1	0x96
	57600	0.15%	426	SYSCLK	XX[2]	1	0x2B
	28800	–0.32%	848	SYSCLK / 4	01	0	0x96
	14400	0.15%	1704	SYSCLK / 12	00	0	0xB9
	9600	–0.32%	2544	SYSCLK / 12	00	0	0x96
	2400	–0.32%	10176	SYSCLK / 48	10	0	0x96
	1200	0.15%	20448	SYSCLK / 48	10	0	0x2B

Notes:
1. SCA1-SCA0 and T1M bit definitions can be found in **Section 15.1**.
2. X = Don't care.

Table 14.2. Timer Settings for Standard Baud Rates Using an External 25 MHz Oscillator

	Frequency: 25.0 MHz						
	Target Baud Rate (bps)	Baud Rate % Error	Oscillator Divide Factor	Timer Clock Source	SCA1–SCA0 (pre-scale select)[1]	T1M[1]	Timer 1 Reload Value (hex)
SYSCLK from External Osc.	230400	–0.47%	108	SYSCLK	XX[2]	1	0xCA
	115200	0.45%	218	SYSCLK	XX[2]	1	0x93
	57600	–0.01%	434	SYSCLK	XX[2]	1	0x27
	28800	0.45%	872	SYSCLK / 4	01	0	0x93
	14400	–0.01%	1736	SYSCLK / 4	01	0	0x27
	9600	0.15%	2608	EXTCLK / 8	11	0	0x5D
	2400	0.45%	10464	SYSCLK / 48	10	0	0x93
	1200	–0.01%	20832	SYSCLK / 48	10	0	0x27
SYSCLK from Internal Osc.	57600	–0.47%	432	EXTCLK / 8	11	0	0xE5
	28800	–0.47%	864	EXTCLK / 8	11	0	0xCA
	14400	0.45%	1744	EXTCLK / 8	11	0	0x93
	9600	0.15%	2608	EXTCLK / 8	11	0	0x5D

Notes:
1. SCA1–SCA0 and T1M bit definitions can be found in **Section 15.1**.
2. X = Don't care

Table 14.5. Timer Settings for Standard Baud Rates Using an External 11.0592 MHz Oscillator

	Frequency: 11.0592 MHz						
	Target Baud Rate (bps)	Baud Rate % Error	Oscillator Divide Factor	Timer Clock Source	SCA1-SCA0 (pre-scale select)[1]	T1M[1]	Timer 1 Reload Value (hex)
SYSCLK from External Osc.	230400	0.00%	48	SYSCLK	XX[2]	1	0xE8
	115200	0.00%	96	SYSCLK	XX[2]	1	0xD0
	57600	0.00%	192	SYSCLK	XX[2]	1	0xA0
	28800	0.00%	384	SYSCLK	XX[2]	1	0x40
	14400	0.00%	768	SYSCLK / 12	00	0	0xE0
	9600	0.00%	1152	SYSCLK / 12	00	0	0xD0
	2400	0.00%	4608	SYSCLK / 12	00	0	0x40
	1200	0.00%	9216	SYSCLK / 48	10	0	0xA0
SYSCLK from Internal Osc.	230400	0.00%	48	EXTCLK / 8	11	0	0xFD
	115200	0.00%	96	EXTCLK / 8	11	0	0xFA
	57600	0.00%	192	EXTCLK / 8	11	0	0xF4
	28800	0.00%	384	EXTCLK / 8	11	0	0xE8
	14400	0.00%	768	EXTCLK / 8	11	0	0xD0
	9600	0.00%	1152	EXTCLK / 8	11	0	0xB8

Notes:

1. SCA1–SCA0 and T1M bit definitions can be found in **Section 15.1**.
2. X = Don't care

16.2.3. High Speed Output Mode

In High Speed Output mode, a module's associated CEXn pin is toggled each time a match occurs between the PCA Counter and the module's 16-bit capture/compare register (PCA0CPHn and PCA0CPLn) Setting the TOGn, MATn, and ECOMn bits in the PCA0CPMn register enables the High-Speed Output mode.

Important Note About Capture/Compare Registers: When writing a 16-bit value to the PCA0 Capture/ Compare registers, the low byte should always be written first. Writing to PCA0CPLn clears the ECOMn bit to '0'; writing to PCA0CPHn sets ECOMn to '1'.

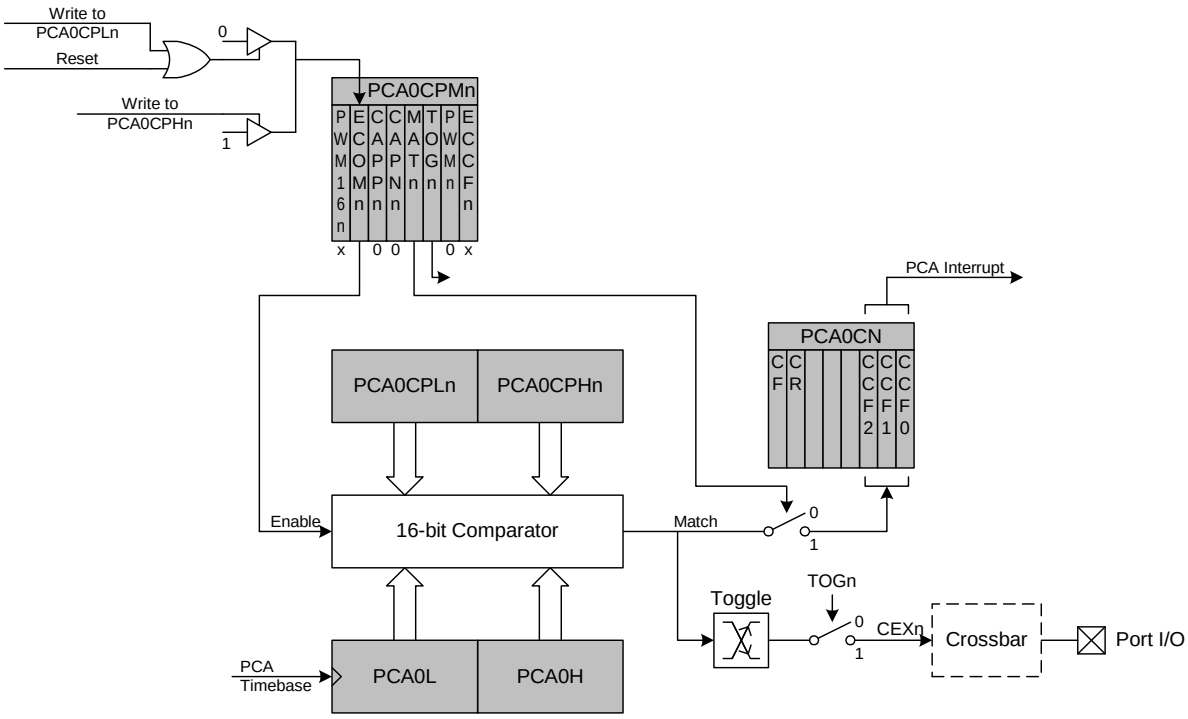

Figure 16.6. PCA High Speed Output Mode Diagram

16.3. Watchdog Timer Mode

A programmable watchdog timer (WDT) function is available through the PCA Module 2. The WDT is used to generate a reset if the time between writes to the WDT update register (PCA0CPH2) exceed a specified limit. The WDT can be configured and enabled/disabled as needed by software.

With the WDTE bit set in the PCA0MD register, Module 2 operates as a watchdog timer (WDT). The Module 2 high byte is compared to the PCA counter high byte; the Module 2 low byte holds the offset to be used when WDT updates are performed. **The Watchdog Timer is enabled on reset. Writes to some PCA registers are restricted while the Watchdog Timer is enabled.**

16.3.1. Watchdog Timer Operation

While the WDT is enabled:

- PCA counter is forced on.
- Writes to PCA0L and PCA0H are not allowed.
- PCA clock source bits (CPS2–CPS0) are frozen.
- PCA Idle control bit (CIDL) is frozen.
- Module 2 is forced into software timer mode.
- Writes to the module 2 mode register (PCA0CPM2) are disabled.

While the WDT is enabled, writes to the CR bit will not change the PCA counter state; the counter will run until the WDT is disabled. The PCA counter run control (CR) will read zero if the WDT is enabled but user software has not enabled the PCA counter. If a match occurs between PCA0CPH2 and PCA0H while the WDT is enabled, a reset will be generated. To prevent a WDT reset, the WDT may be updated with a write of any value to PCA0CPH2. Upon a PCA0CPH2 write, PCA0H plus the offset held in PCA0CPL2 is loaded into PCA0CPH2 (See Figure 16.10).

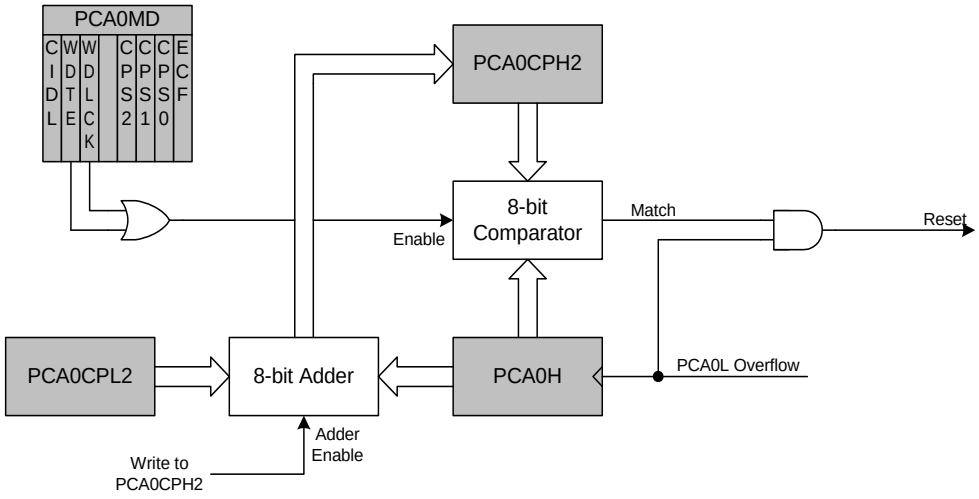

Figure 16.10. PCA Module 2 with Watchdog Timer Enabled

SFR Definition 16.2. PCA0MD: PCA Mode

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
CIDL	WDTE	WDLCK	—	CPS2	CPS1	CPS0	ECF	01000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xD9

Bit7: CIDL: PCA Counter/Timer Idle Control.
Specifies PCA behavior when CPU is in Idle Mode.
0: PCA continues to function normally while the system controller is in Idle Mode.
1: PCA operation is suspended while the system controller is in Idle Mode.

Bit6: WDTE: Watchdog Timer Enable
If this bit is set, PCA Module 2 is used as the Watchdog Timer.
0: Watchdog Timer disabled.
1: PCA Module 2 enabled as Watchdog Timer.

Bit5: WDLCK: Watchdog Timer Lock
This bit locks/unlocks the Watchdog Timer Enable. When WDLCK is set, the Watchdog Timer may not be disabled until the next system reset.
0: Watchdog Timer Enable unlocked.
1: Watchdog Timer Enable locked.

Bit4: UNUSED. Read = 0b, Write = don't care.

Bits3–1: CPS2–CPS0: PCA Counter/Timer Pulse Select.
These bits select the clock source for the PCA counter

CPS2	CPS1	CPS0	Timebase
0	0	0	System clock divided by 12
0	0	1	System clock divided by 4
0	1	0	Timer 0 overflow
0	1	1	High-to-low transitions on ECI (max rate = system clock divided by 4)
1	0	0	System clock
1	0	1	External clock divided by 8*
1	1	0	Reserved
1	1	1	Reserved

***Note:** External oscillator source divided by 8 is synchronized with the system clock.

Bit0: ECF: PCA Counter/Timer Overflow Interrupt Enable.
This bit sets the masking of the PCA Counter/Timer Overflow (CF) interrupt.
0: Disable the CF interrupt.
1: Enable a PCA Counter/Timer Overflow interrupt when CF (PCA0CN.7) is set.

Note: When the WDTE bit is set to '1', the PCA0MD register cannot be modified. To change the contents of the PCA0MD register, the Watchdog Timer must first be disabled.

SFR Definition 16.3. PCA0CPMn: PCA Capture/Compare Mode

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
PWM16n	ECOMn	CAPPn	CAPNn	MATn	TOGn	PWMn	ECCFn	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
								0xDA, 0xDB, 0xDC

PCA0CPMn Address: PCA0CPM0 = 0xDA (n = 0)
PCA0CPM1 = 0xDB (n = 1)
PCA0CPM2 = 0xDC (n = 2)

Bit7: PWM16n: 16-bit Pulse Width Modulation Enable.
This bit selects 16-bit mode when Pulse Width Modulation mode is enabled (PWMn = 1).
0: 8-bit PWM selected.
1: 16-bit PWM selected.

Bit6: ECOMn: Comparator Function Enable.
This bit enables/disables the comparator function for PCA Module n.
0: Disabled.
1: Enabled.

Bit5: CAPPn: Capture Positive Function Enable.
This bit enables/disables the positive edge capture for PCA Module n.
0: Disabled.
1: Enabled.

Bit4: CAPNn: Capture Negative Function Enable.
This bit enables/disables the negative edge capture for PCA Module n.
0: Disabled.
1: Enabled.

Bit3: MATn: Match Function Enable.
This bit enables/disables the match function for PCA Module n. When enabled, matches of the PCA counter with a module's capture/compare register cause the CCFn bit in PCA0MD register to be set to logic 1.
0: Disabled.
1: Enabled.

Bit2: TOGn: Toggle Function Enable.
This bit enables/disables the toggle function for PCA Module n. When enabled, matches of the PCA counter with a module's capture/compare register cause the logic level on the CEXn pin to toggle. If the PWMn bit is also set to logic 1, the module operates in Frequency Output Mode.
0: Disabled.
1: Enabled.

Bit1: PWMn: Pulse Width Modulation Mode Enable.
This bit enables/disables the PWM function for PCA Module n. When enabled, a pulse width modulated signal is output on the CEXn pin. 8-bit PWM is used if PWM16n is cleared; 16-bit mode is used if PWM16n is set to logic 1. If the TOGn bit is also set, the module operates in Frequency Output Mode.
0: Disabled.
1: Enabled.

Bit0: ECCFn: Capture/Compare Flag Interrupt Enable.
This bit sets the masking of the Capture/Compare Flag (CCFn) interrupt.
0: Disable CCFn interrupts.
1: Enable a Capture/Compare Flag interrupt request when CCFn is set.

17.2. C2 Pin Sharing

The C2 protocol allows the C2 pins to be shared with user functions so that in-system debugging and Flash programming functions may be performed. This is possible because C2 communication is typically performed when the device is in the halt state, where all on-chip peripherals and user software are stalled. In this halted state, the C2 interface can safely ‘borrow’ the C2CK (normally RST) and C2D (normally P0.7) pins. In most applications, external resistors are required to isolate C2 interface traffic from the user application. A typical isolation configuration is shown in Figure 17.1.

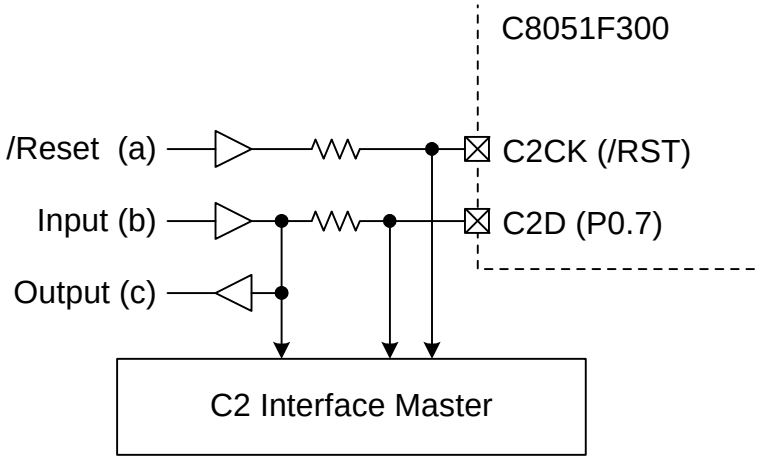

Figure 17.1. Typical C2 Pin Sharing

The configuration in Figure 17.1 assumes the following:

1. The user input (b) cannot change state while the target device is halted.
2. The RST pin on the target device is used as an input only.

Additional resistors may be necessary depending on the specific application.

Document Change List

Revision 2.3 to Revision 2.4

- Removed preliminary tag.
- Changed all references of MLP package to QFN package.
- Pinout chapter: Figure 4.3: Changed title to “Typical QFN-11 Solder Paste Mask.”
- ADC chapter: Added reference to minimum tracking time in the Tracking Modes section.
- Comparators chapter: SFR Definition 7.3, CPT0MD: Updated the register reset value and the CP0 response time table.
- CIP51 chapter: Updated IDLE mode and recommendations.
- CIP51 chapter: Updated Interrupt behavior and EA recommendations.
- CIP51 chapter: SFR Definition 8.4, PSW: Clarified OV flag description.
- CIP51 chapter: SFR Definition 8.8, IP register: Changed “default priority order” to “low priority” for low priority descriptions.
- Reset Sources chapter: Clarified description of VDD Ramp Time.
- Reset Sources chapter: Table 9.2, “Reset Electrical Characteristics”: Added VDD Ramp Time and changed “VDD POR Threshold” to “VDD Monitor Threshold.”
- FLASH Memory chapter: Clarified descriptions of FLASH security features.
- Oscillators chapter: Table 11.1 “Internal Oscillator Electrical Characteristics”: Added Calibrated Internal Oscillator specification over a smaller temperature range.
- Oscillators chapter: Clarified external crystal initialization steps and added a specific 32.768 kHz crystal example.
- Oscillators chapter: Clarified external capacitor example.
- SMBus chapter: Figure 14.5, SMB0CF register: Added a description of the behavior of Timer 3 in split mode if SMBTOE is set.
- Timers chapter: Changed references to “TL2” and “TH2” to “TMR2L” and “TMR2H,” respectively.

Revision 2.4 to Revision 2.5

- Fixed variables and applied formatting changes.

Revision 2.5 to Revision 2.6

- Updated Table 1.1 Product Selection Guide to include Lead-free information.

Revision 2.6 to Revision 2.7

- Removed non-RoHS compliant devices from Table 1.1, “Product Selection Guide,” on page 14.
- Added MIN and MAX specifications for ADC Offset Error and ADC Full Scale Error to Table 5.1, “ADC0 Electrical Characteristics,” on page 47.
- Improved power supply specifications in Table 3.1, “Global Electrical Characteristics,” on page 25.
- Added **Section “10.4. Flash Write and Erase Guidelines” on page 94**.
- Fixed minor typographical errors throughout.

Revision 2.7 to Revision 2.8

- Updated block diagram on page 1.

Revision 2.8 to Revision 2.9

- Updated QFN package drawings and notes.
- Added SOIC-14 package information.
- Added text to CPT0CN's SFR definition to indicate that the SFR is bit addressable.
- Changed SMBus maximum transfer speed from 1/10th system clock to 1/20th system clock in SMBus section.
- Added information pertaining to Slave Receiver and Slave Transmitter states in Table 13.4.
- Changed Table 5.1 and Figure 5.4 to indicate that 11 SAR clocks are needed for a SAR conversion to complete.
- Changed SCON0s SFR definition to show that SCON0 bit 6 always resets to a value of 1.